

## Features

- 2 channel, bidirectional buffer isolates capacitance and allows 540pF on either side of the device at 1 MHz and up to 4000 pF at lower speeds
- Voltage level translation from 0.6V to 5.5V and from 2.2V to 5.5V
- Footprint and functional replacement for PI6ULS5V9617A at Fast-mode speeds
- Port A operating supply voltage range of 0.6V to 5.5V with normal levels( $0.4V_{CC(A)} + 0.8V \leq V_{CC(B)}$ )
- Port B operating supply voltage range of 2.2V to 5.5V with static offset level
- 5V tolerant I<sup>2</sup>C-bus and enable pins
- 0 Hz to 1 MHz clock frequency (the maximum system operating frequency may be less than 1MHz because of the delays added by the repeater)
- Active HIGH repeater enable input referenced to  $V_{CC(B)}$
- Open-drain input/outputs
- Latching free operation
- Supports arbitration and clock stretching across the repeater
- Accommodates Standard-mode, Fast-mode and Fast-mode Plus I<sup>2</sup>C-bus devices, SMBus (standard and high power mode), PMBus and multiple masters
- Powered-off high-impedance I<sup>2</sup>C-bus pins
- ESD protection exceeds 8000V HBM per JESD22-A114
- Package: MSOP-8L, SOIC-8L and TDFN2x3-8L

## Pin Description

Pin Name	Description
$V_{CC(A)}$	port A supply voltage (0.6V to 5.5V)
SCLA	serial clock port A bus
SDAA	serial data port A bus
GND	supply ground (0 V)
EN	active HIGH repeater enable input
SDAB	serial data port B bus
SCLB	serial clock port B bus
$V_{CC(B)}$	port B supply voltage (2.2V to 5.5V)

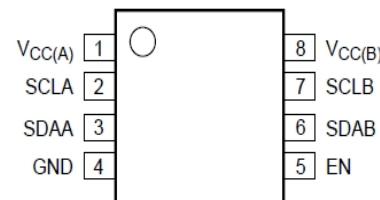
## Description

The PI6ULS5V9617A is a CMOS integrated circuit intended for Fast-mode Plus (Fm+) I<sup>2</sup>C-bus or SMBus applications. It can provide level shifting between low voltage (down to 0.6V) and higher voltage (2.2V to 5.5V) in mixed-mode applications.

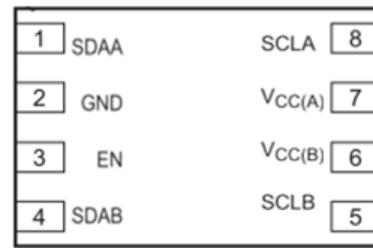
The PI6ULS5V9617A enables the system designer to isolate two halves of a bus for both voltage and capacitance, accommodating more I<sup>2</sup>C devices or longer trace length. It also permits extension of the I<sup>2</sup>C-bus by providing bidirectional buffering for both the data (SDA) and the clock (SCL) lines, thus enabling two buses of 540 pF at 1 MHz or up to 4000 pF at lower speeds. The SDA and SCL pins are overvoltage tolerant and are high-impedance when the PI6ULS5V9617A is unpowered.

The 2.2V to 5.5V bus port B drivers have the static level offset, while the adjustable voltage bus port A drivers eliminate the static offset voltage. This results in a LOW on the port B translating into a nearly 0V LOW on the port A which accommodates the smaller voltage swings of lower voltage logic. The EN pin is referenced to  $V_{CC(B)}$  and can also be used to turn the drivers on and off under system control.

## Pin Configuration

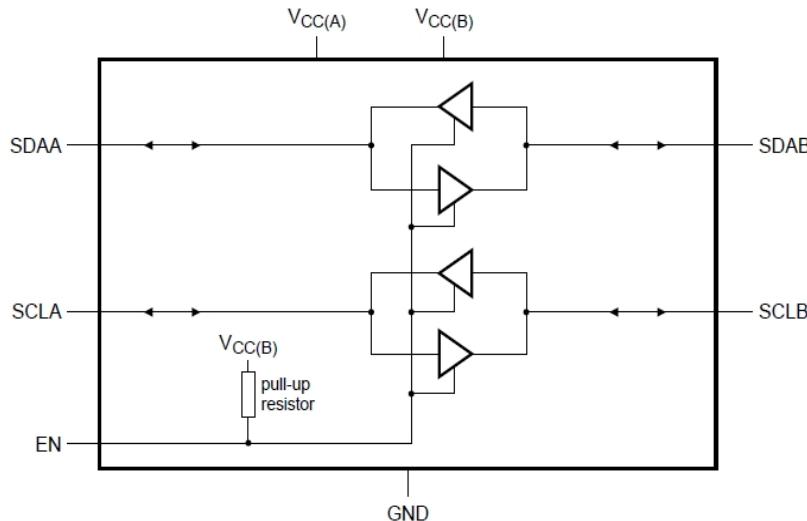


MSOP-8L, SOIC-8L(Top View)



TDFN2\*3-8L(Top View)

## Block Diagram



EN	Function
H	SCLA = SCLB; SDAA = SDAB;
L	disabled

Figure 1: Block Diagram

## Maximum Ratings

Storage Temperature	-55°C to +125°C
Supply Voltage port B	-0.5V to +6.0V
Supply Voltage port A	-0.5V to +6.0V
DC Input Voltage	-0.5V to +6.0V
Control Input Voltage (EN)	-0.5V to +6.0V
Total Power Dissipation	100mW
Input/Output Current (port A&B)	50mA
Input current (EN, VCCA, VCCB, GND)	50mA
ESD: HBM Mode	8000V

### Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

## DC Electrical Characteristics

$V_{CC(A)} = 0.6V$  to  $5.5V^{(1)}$ ;  $V_{CC(B)} = 2.2V$  to  $5.5V$ ;  $GND = 0V$ ;  $T_A = -40^\circ C$  to  $+85^\circ C$ ; unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$V_{CC(B)}$	supply voltage port B	-	2.2	-	5.5	V
$V_{CC(A)}$	supply voltage port A	-	0.6	-	5.5	V
$I_{CC(A)}$	supply current on pin $V_{CC(A)}$	$V_{CC(A)} = 0.95V$	-	-	8	$\mu A$
		$V_{CC(A)} = 5.5V$	-	-	50	
$I_{CC(B)}$	port B HIGH-level supply current	$V_{CC(B)} = 5.5V$ $SDAn = SCLn = V_{CC(n)}$	-	0.8	2.5	mA
$I_{CCL(B)}$	port B LOW-level supply current	$V_{CC(B)} = 5.5V$ ; one SDA and one SCL = GND; other SDA and SCL open (with pull-up resistors)	-	1.7	2.9	mA
$I_{QVC(B)}$	Quiescent current on $V_{CC(B)}$	$EN = GND; V_{CC(B)} = 5.5V$	-	0.4	0.8	mA

### Note:

(1)  $V_{CC(A)}$  may be as high as  $5.5V$  for over voltage tolerance but  $0.4V_{CC(A)} + 0.8V \leq V_{CC(B)}$  for the channels to be enabled and functional normally.

## DC Electrical Characteristics

$V_{CC(A)} = 0.6V$  to  $5.5V^{(5)}$ ;  $V_{CC(B)} = 2.2V$  to  $5.5V$ ; GND = 0V;  $T_A = -40^\circ C$  to  $+85^\circ C$ ; Typical values measured with  $V_{CC(A)} = 0.95V$  and  $V_{CC(B)} = 2.5V$ , unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
<b>Input and output SDAB and SCLB</b>						
$V_{IH}$	HIGH-level input voltage	-	$0.7V_{CC(B)}$	-	5.5	V
$V_{IL}$	LOW-level input voltage	-	-0.5	-	+0.4	V
$V_{IK}$	Input clamping voltage	$I_I = -18\text{ mA}$	-1.2	-	-	V
$I_{LI}$	Input leakage current	$V_I = 5.5V$	-	-	$\pm 1$	$\mu A$
$I_{IL}$	LOW-level input current	SDA, SCL; $V_I = 0.2\text{ V}$	-	-	10	$\mu A$
$V_{OL}$	LOW-level output voltage	$I_{OL} = 150\mu A$ at $V_{CC(B)} = 2.2V^{(1)}$	0.47	-	-	V
		$I_{OL} = 13\text{mA}$ at $V_{CC(B)} = 2.2V^{(2)}$	-	0.54	0.60	V
$V_{OL} - V_{IL}$	Difference between LOW-level output and LOW-level input voltage contention	$V_{OL}$ at $I_{OL} = 1\text{ mA}$ ; guaranteed by design	60	90	160	mV
$C_{io}$	Input/output capacitance	$V_I = 3V$ or $0V$ ; $V_{CC(B)} = 3.3V$ ; EN = LOW	-	7	10	pF
		$V_I = 3V$ or $0V$ ; $V_{CC(B)} = 0V$	-	7	10	pF
<b>Input and output SDAA and SCLA</b>						
$V_{IH}$	HIGH-level input voltage	-	$0.7V_{CC(A)}$	-	5.5	V
$V_{IL}$	LOW-level input voltage	-	-0.5 <sup>(3)</sup>	-	$+0.25V_{CC(A)}^{(4)}$	V
$V_{IK}$	Input clamping voltage	$I_I = -18\text{ mA}$	-1.2	-	-	V
$I_{LI}$	Input leakage current	$V_I = 5.5V$	-	-	$\pm 1$	$\mu A$
$I_{IL}$	LOW-level input current	SDA, SCL; $V_I = 0.2\text{ V}$	-	-	10	$\mu A$
$V_{OL}$	LOW-level output voltage	$I_{OL} = 13\text{mA}$ at $V_{CC(B)} = 2.2V$	-	0.1	0.2	V
$C_{io}$	Input/output capacitance	$V_I = 3V$ or $0V$ ; $V_{CC(B)} = 3.3V$ ; EN = LOW	-	7	10	pF
		$V_I = 3V$ or $0V$ ; $V_{CC(B)} = 0V$	-	7	10	pF
<b>Enable</b>						
$V_{IH}$	HIGH-level input voltage	-	$0.7V_{CC(B)}$	-	5.5	V
$V_{IL}$	LOW-level input voltage	-	-0.5	-	$+0.3V_{CC(B)}$	V
$I_{LI}$	Input leakage current	$V_I = V_{CC(B)}$	-1	-	$\pm 1$	$\mu A$
$I_{IL}$	LOW-level input current	$V_I = 0.2V$ , EN; $V_{CC(B)} = 2.2V$ ;	-18	-7	-	$\mu A$
$C_{io}$	Input capacitance	$V_I = V_{CC(B)}$	-	6	-	pF

Note:

- (1) Pull-up should result in  $I_{OL} \geq 150\mu A$ .
- (2) Guaranteed by design and characterization.
- (3)  $V_{IL}$  for port A with envelope noise must be below  $0.3V_{CC(A)}$  for stable performance.
- (4) When  $V_{CC(A)}$  is less than 1V, care is required to make certain that the system ground offset and noise is minimized such that there is reasonable difference between the  $V_{IL}$  present at the PI6ULS5V9617 A-side input and the  $0.25V_{CC(A)}$  input threshold.
- (5)  $V_{CC(A)}$  may be as high as 5.5 V for over voltage tolerance but  $0.4V_{CC(A)} + 0.8V \leq V_{CC(B)}$  for the channels to be enabled and functional normally.

Figure 2:  
Port B  $V_{OL}$  versus  $I_{OL}$

Condition:  
 $V_{CCB}=2.2V, T_A=25^\circ C$   
 $V_{CCB}=2.2V, T_A=85^\circ C$   
 $V_{CCB}=3V, T_A=85^\circ C$

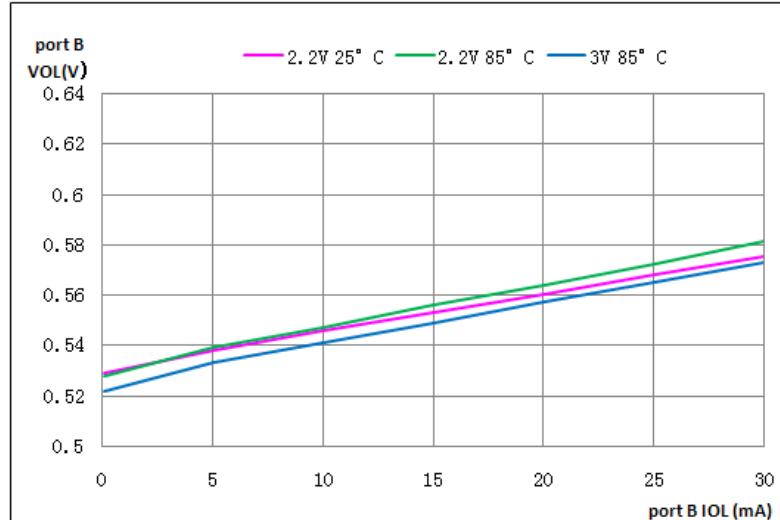


Figure 3:  
Port A  $V_{OL}$  versus  $I_{OL}$

Condition:  
 $V_{CCA}=2.2V, T_A=25^\circ C$   
 $V_{CCA}=2.2V, T_A=85^\circ C$

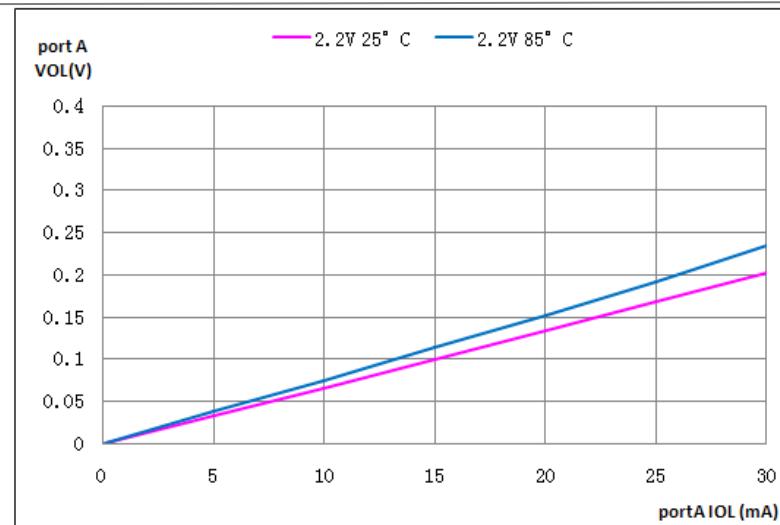
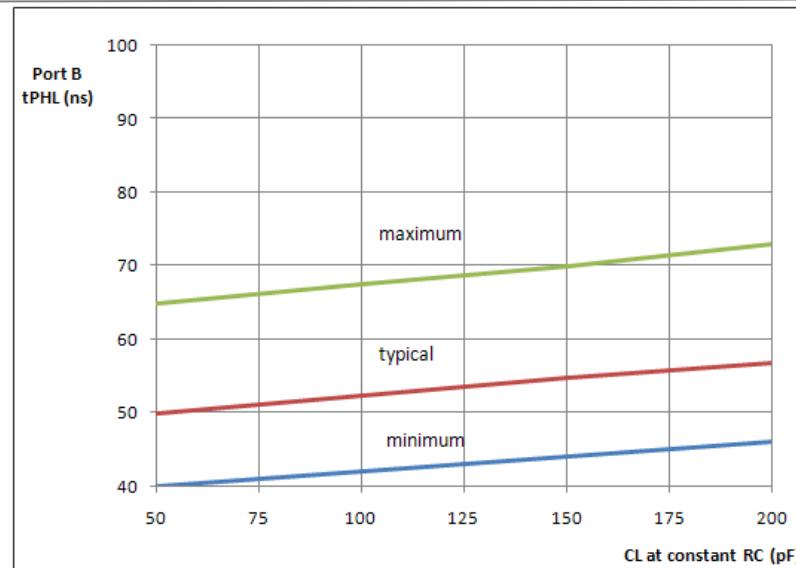


Figure 4:  
Nominal port B  $t_{PHL}$  with load  
capacitance at constant RC

Condition:  
 $RC = 67.5 \text{ ns}, V_{CC(A)} = 0.95 \text{ V},$   
 $V_{CC(B)} = 2.5 \text{ V}, T_A = 25^\circ C$



## Dynamic characteristics

$V_{CC(A)} = 0.6V$  to  $5.5V^{(8)}$ ;  $V_{CC(B)} = 2.2V$  to  $5.5V$ ;  $GND = 0V$ ;  $T_A = -40^\circ C$  to  $+85^\circ C$ ; Typical values measured with  $V_{CC(A)} = 0.95V$  and  $V_{CC(B)} = 2.5V$ , unless otherwise noted.<sup>(1)(2)</sup>

Symbol	Parameter	Conditions	Min.	Typ. <sup>[3]</sup>	Max.	Unit
$t_{PLH}$	LOW-to-HIGH propagation delay	B-side to A-side	-	-52	-103	ns
$t_{PLH2}^{[4]}$	LOW-to-HIGH propagation delay2	B-side to A-side	-	94	130	ns
$t_{PHL}$	HIGH-to-LOW propagation delay	B-side to A-side	-	76	152	ns
$t_{TLH}^{[5]}$	LOW-to-HIGH transition time	A-side	-	60	-	ns
SRf	Falling slew rate	port A; $0.7V_{CC(A)}$ to $0.3V_{CC(A)}$	-	0.037	-	ns
$t_{PLH}^{[6]}$	LOW-to-HIGH propagation delay	A-side to B-side	-	45	102	ns
$t_{PHL}^{[6]}$	HIGH-to-LOW propagation delay	A-side to B-side	-	50	173	ns
$t_{TLH}$	LOW-to-HIGH transition time	B-side	-	60	-	ns
$t_{THL}$	HIGH-to-LOW transition time	B-side	-	30	76	ns
$t_{en}^{[7]}$	Enable time	Quiescent $-0.3V$ ; EN HIGH to enable;	-	-	100	ns
$t_{dis}^{[7]}$	Disable time	quiescent $+0.3V$ ; EN LOW to disable;	-	-	100	ns

### Note:

- (1) Times are specified with loads of  $1.35\text{ k}\Omega$  pull-up resistance and  $50\text{ pF}$  load capacitance on port A and port B, and a falling edge slew rate of  $0.05\text{ V/ns}$  input signals.
- (2) Pull-up voltages are  $V_{CC(A)}$  on port A and  $V_{CC(B)}$  on port B.
- (3) Typical values were measured with  $V_{CC(A)} = 0.95\text{ V}$ ,  $V_{CC(B)} = 2.5\text{ V}$  at  $T_A = 25^\circ C$ , unless otherwise noted.
- (4) The  $t_{PLH2}$  delay data from port B to port A is measured at  $0.45\text{ V}$  on port B to  $0.5V_{CC(A)}$  on port A.
- (5) The  $t_{TLH}$  of the bus is determined by the pull-up resistance ( $1.35\text{ k}\Omega$ ) and the total capacitance ( $50\text{ pF}$ ).
- (6) The proportional delay data from port A to port B is measured at  $0.5V_{CC(A)}$  on port A to  $0.5V_{CC(B)}$  on port B.
- (7) The enable pin, EN, should only change state when the global bus and the repeater port are in an idle state.
- (8)  $V_{CC(A)}$  may be as high as  $5.5\text{ V}$  for over voltage tolerance but  $0.4V_{CC(A)} + 0.8\text{ V} \leq V_{CC(B)}$  for the channels to be enabled and functional normally.

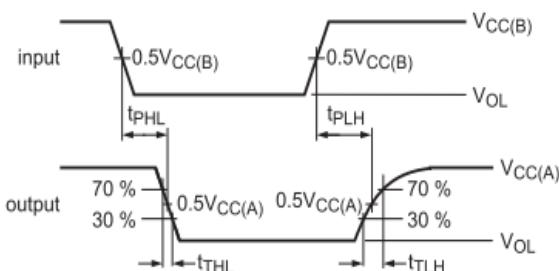


Figure 5: Propagation Delay and Transition Times B→A

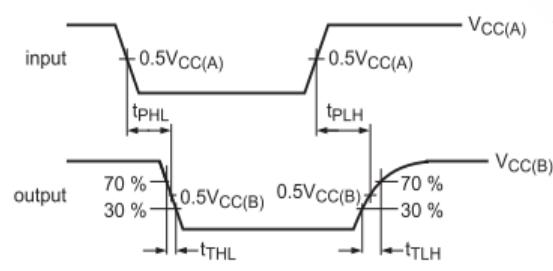


Figure 6: Propagation Delay and Transition Times A→B

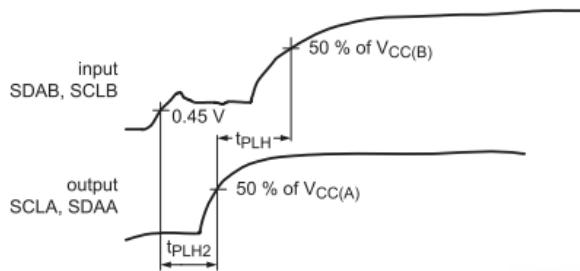
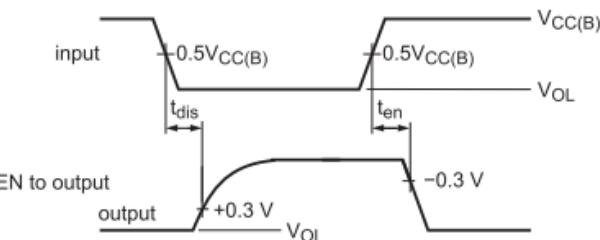
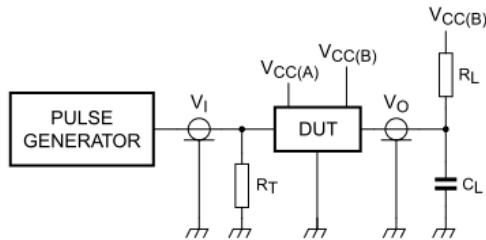


Figure 7: Propagation Delay and Enable and disable time





$R_L$  = load resistor; 1.35 k $\Omega$  on port B

$C_L$  = load capacitance includes jig and probe capacitance; 50 pF

$R_T$  = termination resistance should be equal to  $Z_0$  of pulse generators

Figure 8: Test Circuit

## Functional Description

The PI6ULS5V9617A enables I<sup>2</sup>C-bus or SMBus translation down to  $V_{CC(A)}$  as low as 0.6V without degradation of system performance. The PI6ULS5V9617A contains two bidirectional open-drain buffers specifically designed to support up-translation/down-translation between the low voltage (as low as 0.6V) and a 2.5V, 3.3V or 5V I<sup>2</sup>C-bus or SMBus. All inputs and I/Os are overvoltage tolerant to 5.5V even when the device is unpowered ( $V_{CC(B)}$  and/or  $V_{CC(A)}$  = 0V).

The PI6ULS5V9617A includes a power-up circuit that keeps the output drivers turned off until  $V_{CC(B)}$  is above 2.2V and until after the internal reference circuits have settled at about 400 $\mu$ s, and the  $V_{CC(A)}$  is above 0.6V.  $V_{CC(B)}$  and  $V_{CC(A)}$  can be applied in any sequence at power-up.

The PCA9617A includes a  $V_{CC(A)}$  overvoltage disable that turns the channel off if  $0.4V_{CC(A)} + 0.8V > V_{CC(B)}$ . The PCA9617A logic and all I/Os are powered by the  $V_{CC(B)}$  pin.

The B-side drivers operate from 2.2V to 5.5V. The output low level of port B internal buffer is approximately 0.55 V, while the input voltage must be 90mV lower (0.45V) or even more lower. The nearly 0.5V low signal is called a buffered low. When the B-side I/O is driven low internally, the low is not recognized as a low by the input. This feature prevents a lockup condition from occurring when the input low condition is released. This type of design on B port prevents it from being used in series with another PI6ULS5V9617A (B side) or similar devices, because they don't recognize buffer low signals as a valid low.

The A-side drivers operate from 0.6V to 5.5 V. The output low level of port A internal buffer is nearly 0V, while the input low level is set at  $0.35V_{CC(A)}$  to accommodate the need for a lower LOW level in systems where the low voltage side supply voltage is as low as 0.6V. Port A of two or more PI6ULS5V9617As can be connected together to allow a star topography with port A on the common bus. And port A can be connected directly to any other buffer with static or dynamic offset voltage. Multiple PI6ULS5V9617As can be connected in series, port A to port B, with no build-up in offset voltage with only time of flight delays to consider.

After power-up and with the EN HIGH, a LOW level on port A (below  $0.3V_{CC(A)}$ ) turns the corresponding port B driver (either SDA or SCL) on and drives port B down to about 0.55 V. When port A rises above  $0.3V_{CC(A)}$ , the port B pull-down driver is turned off and the external pull-up resistor pulls the pin HIGH. When port B falls first and goes below 0.4 V, the port A driver is turned on and port A pulls down to about 0 V. The port A pull-down is not enabled unless the port B voltage goes below 0.4 V. If the port B low voltage goes below 0.4 V, the port B pull-down driver is enabled and port B will only be able to rise to 0.55 V until port A rises above  $0.3V_{CC(A)}$ , then port B will continue to rise being pulled up by the external pull-up resistor. The  $V_{CC(A)}$  is only used to provide the  $0.35V_{CC(A)}$  reference to the port A input comparators and for the power good detect circuit. The PI6ULS5V9617A logic and all I/Os are powered by the  $V_{CC(B)}$  pin.

The EN pin is active HIGH with thresholds referenced to  $V_{CC(B)}$  and an internal pull-up to  $V_{CC(B)}$  that maintains the device active unless the user selects to disable the repeater to isolate a badly behaved slave on power-up until after the system power-up reset. It should never change state during an I<sup>2</sup>C-bus operation because disabling during a bus operation will hang the bus and enabling part way through a bus cycle could confuse the I<sup>2</sup>C-bus parts being enabled. The enable does not switch the internal reference circuits so the 400 $\mu$ s delay is only seen when  $V_{CC(B)}$  comes up. The

enable pin should only change state when the global bus and the repeater port are in an idle state to prevent system failures.

As with the standard I<sup>2</sup>C-bus system, pull-up resistors are required to provide the logic HIGH levels on the buffered bus (standard open-collector configuration of the I<sup>2</sup>C-bus). The size of these pull-up resistors depends on the system, but each side of the repeater must have a pull-up resistor. This part designed to work with Standard mode, Fast-mode and Fast-mode Plus I<sup>2</sup>C-bus devices in addition to SMBus devices. Standard mode and Fast-mode I<sup>2</sup>C-bus devices only specify 3mA output drive; this limits the termination current to 3mA in a generic I<sup>2</sup>C-bus system where Standard-mode devices, Fast-mode devices and multiple masters are possible. When only Fast-mode Plus devices are used with 30mA at 5 V drive strength, then lower value pull-up resistors can be used. The B-side RC should not be less than 67.5 ns because shorter RCs increase the turnaround bounce when the B-side transitions from being externally driven to pulled down by its offset buffer.

## Application Information

A typical application is shown in Figure 9. In this example, the system master is running on a 3.3 V I<sup>2</sup>C-bus while the slave is connected to a 1.2 V bus. Both buses run at 1MHz. Master devices can be placed on either bus.

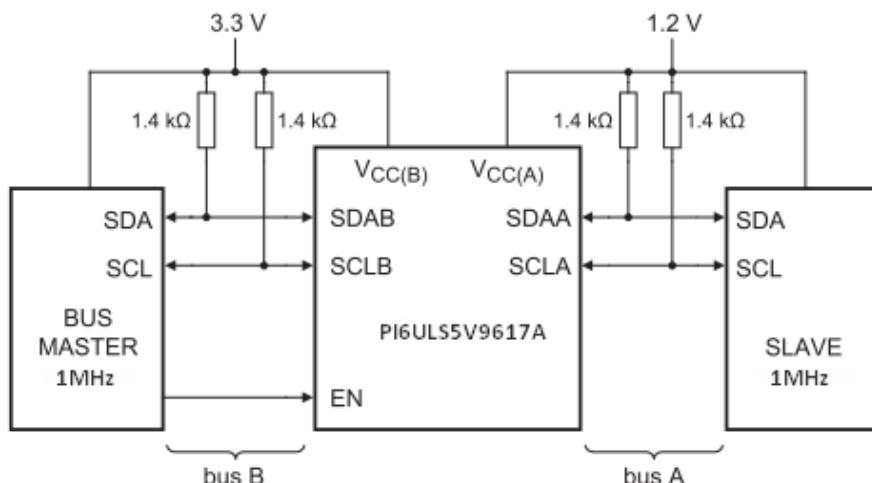


Figure 9: Typical Application

The PI6ULS5V9617A is 5V tolerant, so it does not require any additional circuitry to translate between 0.6V to 5.5V bus voltages and 2.2 V to 5.5 V bus voltages.

When port A of the PI6ULS5V9617A is pulled LOW by a driver on the I<sup>2</sup>C-bus, a comparator detects the falling edge when it goes below 0.3V<sub>CC(A)</sub> and causes the internal driver on port B to turn on, causing port B to pull down to about 0.5 V. When port B of the PI6ULS5V9617A falls, first a CMOS hysteresis type input detects the falling edge and causes the internal driver on port A to turn on and pull the port A pin down to ground. In order to illustrate what would be seen in a typical application, refer to Figure 9 and Figure 10. If the bus master in Figure 9 were to write to the slave through the PI6ULS5V9617A, waveforms shown in Figure 9 would be observed on the A bus. This looks like a normal I<sup>2</sup>C-bus transmission except that the HIGH level may be as low as 0.6V, and the turn on and turn off of the acknowledge signals are slightly delayed.

On the B bus side of the PI6ULS5V9617A, the clock and data lines would have a positive offset from ground equal to the V<sub>OL</sub> of the PI6ULS5V9617A. After the eighth clock pulse, the data line will be pulled to the V<sub>OL</sub> of the slave device which is very close to ground in this example. At the end of the acknowledge, the level rises only to the LOW level set by the driver in the PI6ULS5V9617A for a short delay while the A bus side rises above 0.3V<sub>CC(A)</sub> then

it continues HIGH. It is important to note that any arbitration or clock stretching events require that the LOW level on the B bus side at the input of the PI6ULS5V9617A ( $V_{IL}$ ) be at or below 0.4 V to be recognized by the PI6ULS5V9617A and then transmitted to the A bus side.

Multiple PI6ULS5V9617A port A sides can be connected in a star configuration (Figure 10), allowing all nodes to communicate with each other.

Multiple PI6ULS5V9617As can be connected in series as long as port A is connected to port B(Figure 11). I<sup>2</sup>C-bus slave devices can be connected to any of the bus segments. The number of devices that can be connected in series is limited by repeater delay/time-of-flight considerations on the maximum bus speed requirements.

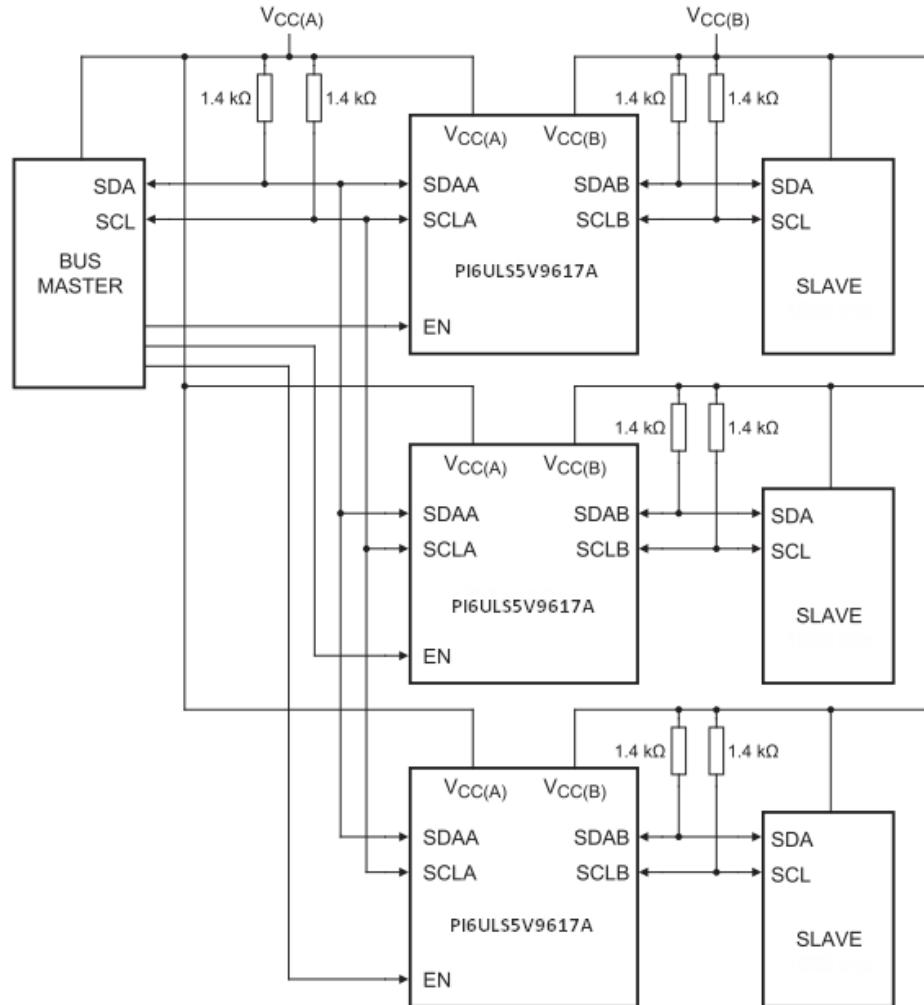


Figure 10: Typical Star Application

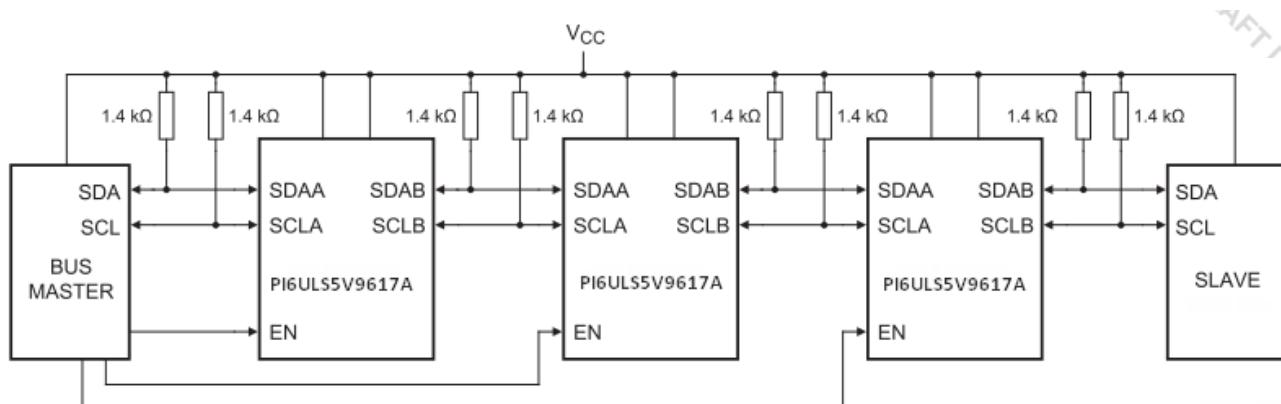


Figure 11: Typical Series Application

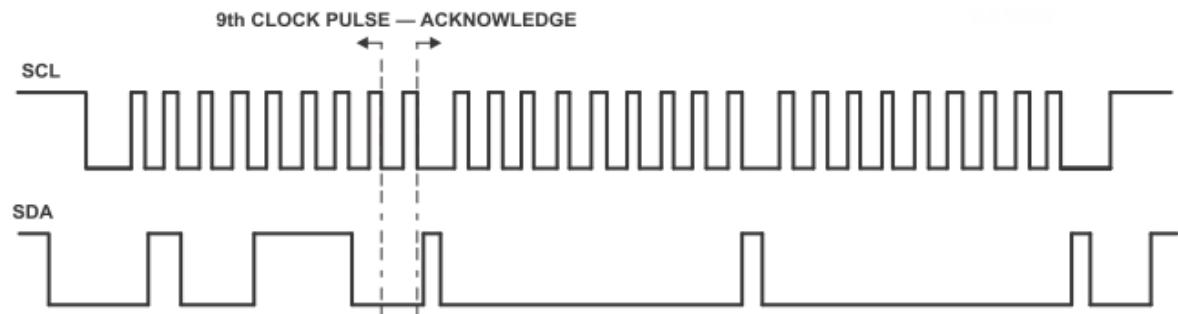


Figure 12: Bus A (0.6V to 5.5V Bus) Waveform

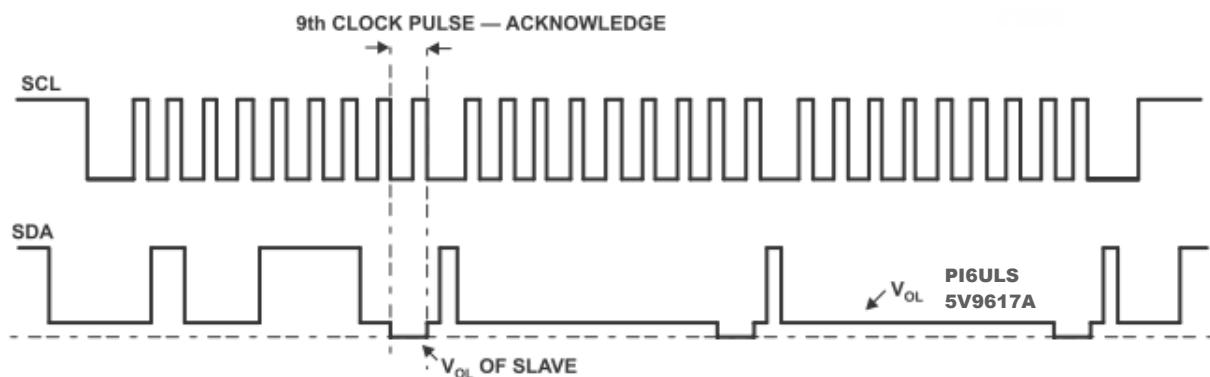
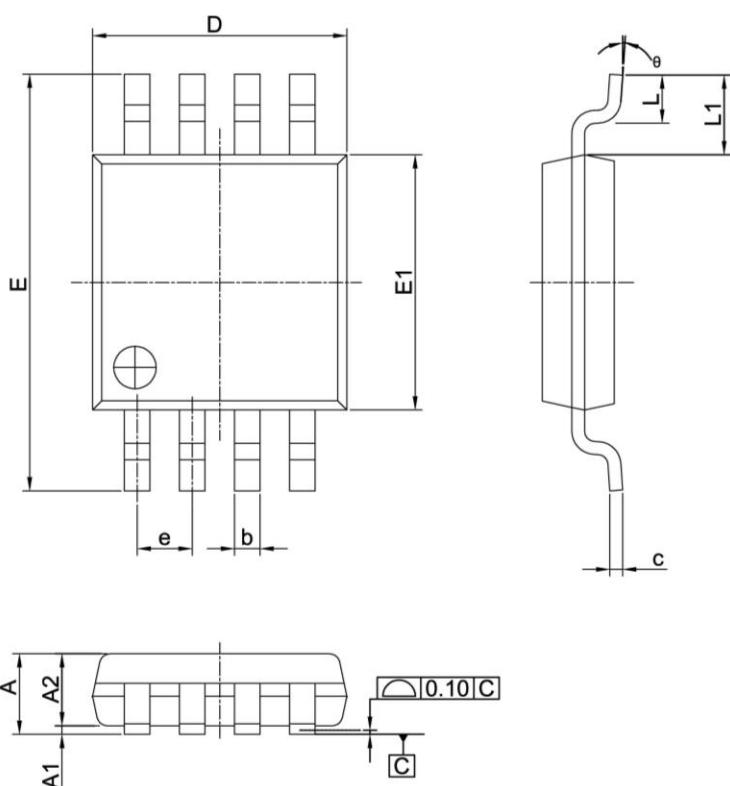


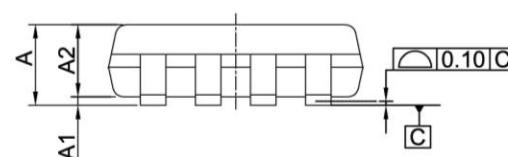
Figure 13: Bus B (2.2V to 5.5V Bus) Waveform

## Mechanical Information

MSOP-8



PKG DIMENSIONS(MM)		
SYMBOL	Min.	Max.
A	--	1.10
A1	0.00	0.15
A2	0.75	0.95
b	0.22	0.38
c	0.08	0.23
D	2.80	3.20
E	4.65	5.15
E1	2.80	3.20
e	0.65 BSC	
L	0.40	0.80
L1	0.95 REF	
θ	0°	8°

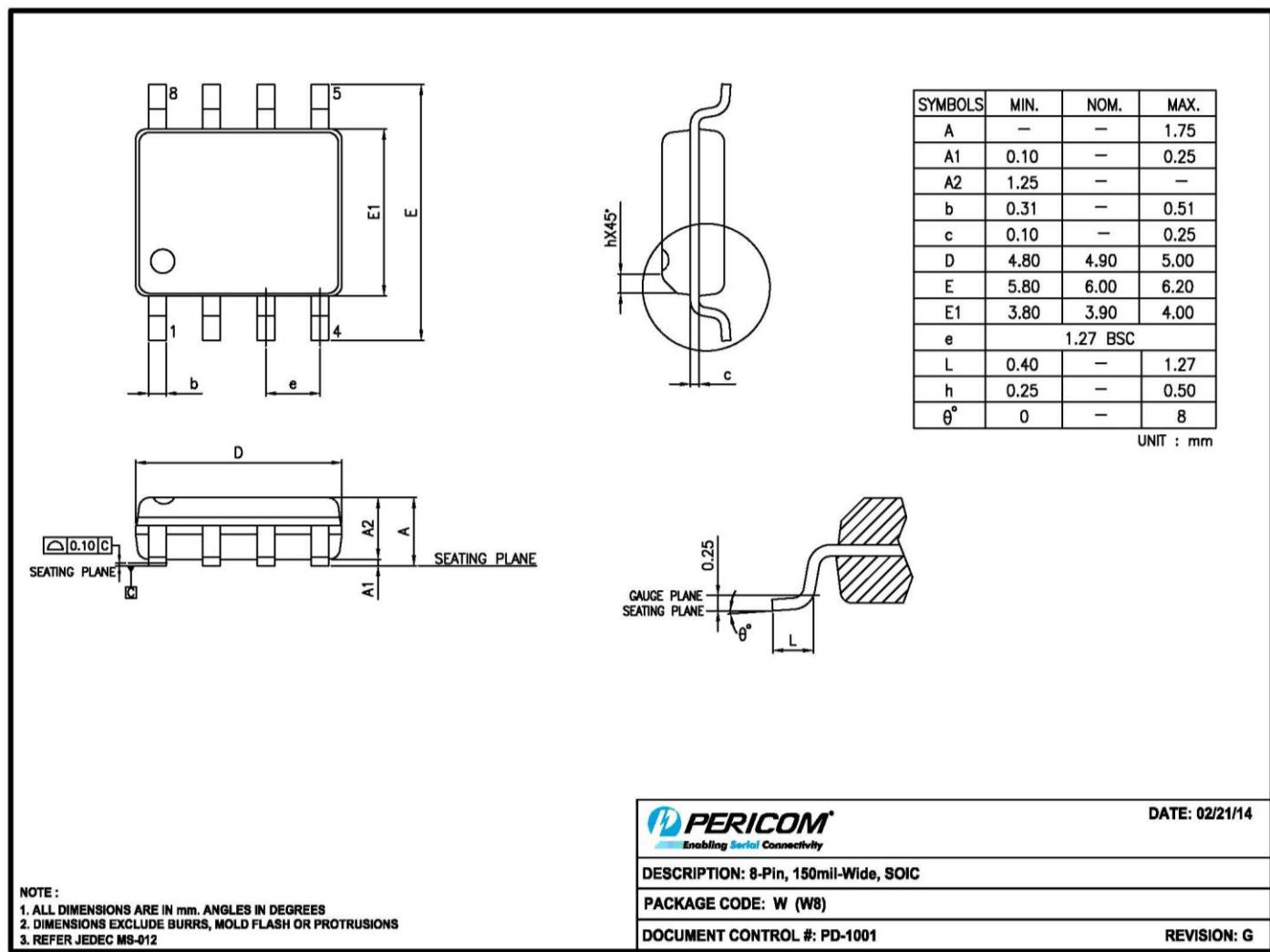


<b>DIODES</b> INCORPORATED	<b>PERICOM</b> A PRODUCT LINE OF DIODES INCORPORATED ENABLING SERIAL CONNECTIVITY	DATE: 11/03/16
DESCRIPTION: 8-Pin, Mini Small Outline Package, MSOP		
PACKAGE CODE: U (U8)		
DOCUMENT CONTROL #: PD-1261		REVISION: G

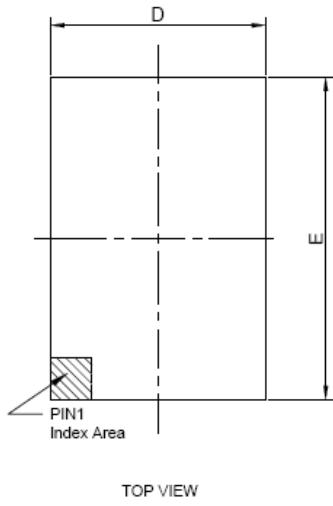
**NOTE:**  
 1. ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES IN DEGREES.  
 2. REFER JEDEC MO-187F/AA  
 3. PACKAGE OUTLINE DIMENSIONS DO NOT INCLUDE MOLD FLASH AND METAL BURR.

16-0242

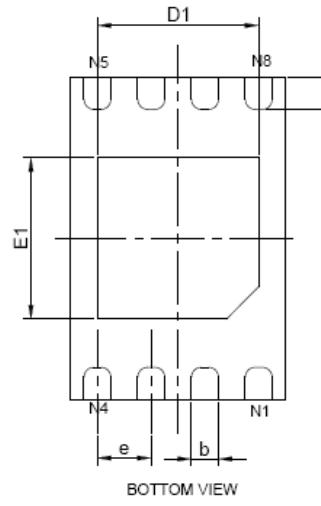
SOIC-8



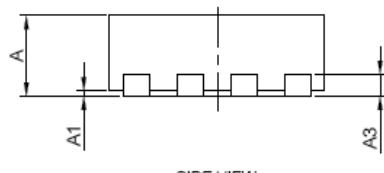
TDFN2x3-8



TOP VIEW



BOTTOM VIEW



SIDE VIEW

PKG. DIMENSIONS(MM)		
SYMBOL	Min	Max
A	0.70	0.80
A1	0.00	0.05
A3	0.20 REF	
D	1.92	2.08
E	2.92	3.07
D1	1.40	1.60
E1	1.40	1.60
k	0.20 MIN	
b	0.20	0.30
e	0.50 TYP	
L	0.22	0.38

Notes:  
1. Ref. JEDEC MO-229

**PERICOM**  
Enabling Serial Connectivity

DATE: 06/14/13

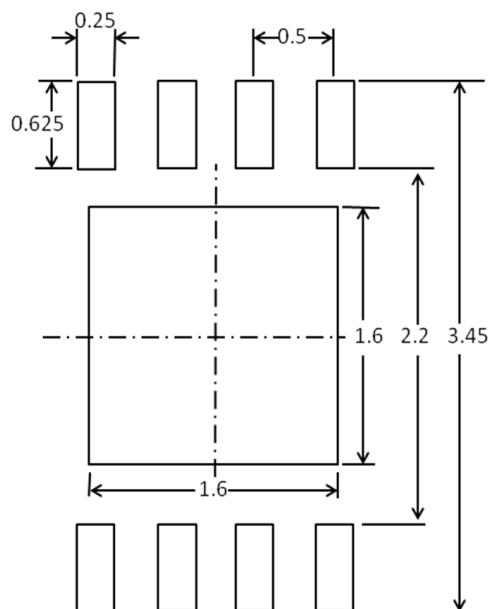
DESCRIPTION: 8-Pin, TDFN, 2x3

PACKAGE CODE: ZE (ZE8)

DOCUMENT CONTROL#: PD-2116

REVISION: --

### Recommended Land pattern for TDFN 2x3-8



Note: All linear dimensions are in millimeters

Note: For latest package info, please check: <http://www.pericom.com/support/packaging/packaging-mechanicals-and-thermal-characteristics/>

### Ordering Information

Part Numbers	Package Code	Package Description
PI6ULS5V9617AUE	U	8-pin, Mini Small Outline Package (MSOP)
PI6ULS5V9617AUEX	U	8-pin, Mini Small Outline Package (MSOP), Tape & Reel
PI6ULS5V9617AWE	W	8-pin, 150mil Wide (SOIC)
PI6ULS5V9617AWEX	W	8-pin, 150mil Wide (SOIC), Tape & Reel
PI6ULS5V9617AZEE	ZE	8-pin, 2X3 (TDFN)
PI6ULS5V9617AZEEEX	ZE	8-pin, 2X3 (TDFN), Tape & Reel

Note:

- Thermal characteristics can be found on the company web site at [www.pericom.com/packaging/](http://www.pericom.com/packaging/)
- E = Pb-free and Green
- Adding X Suffix= Tape/Reel

**PI6ULS5V9617A****IMPORTANT NOTICE**

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel.

Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

**LIFE SUPPORT**

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

- A. Life support devices or systems are devices or systems which:
  - 1. are intended to implant into the body, or
  - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2016, Diodes Incorporated  
[www.diodes.com](http://www.diodes.com)